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Press Release

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SEMICONDUCTOR PACKAGING COMPANY INVESTS IN NEW VENTURE

HAYWARD, CA, JANUARY 10, 2006: Delphon Industries announced its acquisition of TouchMark, Inc. of Hayward, CA. The move is part of an ongoing strategy to merge innovative technologies in order to provide unique materials and services for the packaging, shipping and process handling of high value technology devices. "With TouchMark's expertise in high quality pad printing on a wide variety of surfaces, we will be able to offer our customers an even greater degree of customization for their unique packaging needs" says Jeanne Beacham CEO of Delphon Industries.

Touchmark, established in 1992, provides customers with high quality pad printing services such as company logos, graphics, and part identification. Services are available for

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prototypes or full production parts and range from printing on large panels to microscopic printing for medical applications. The company also provides graphic design and assembly services. "We consider ourselves to be THE Pad Printing Experts. We have successfully pad printed on difficult substrates such as Santoprene, Polypropylene, Polycarbonate, rubber and powder coated metals. We have even applied pad printing in recessed and difficult to reach areas" said Gary Jones, President of TouchMark, Inc.

About Delphon:

Delphon Industries, LLC was started in 2004 in order to provide a platform for future growth in merging innovative technologies. The company specializes in bringing together unique packaging solutions in order to meet the specific needs of its customers. Under its corporate umbrella, the company operates Gel-Pak of Hayward, CA and Quik-Pak of San Diego, CA.

Gel-Pak products are used in a wide variety of industries that require the proprietary Gel solution for the safe shipping and handling of leading edge technologies. When companies around the world need to transport valuable devices without risk of damage, they rely on products made by Gel-Pak.

Quik-Pak uses its patented Open-Cavity Package technology and complementary assembly services to produce IC prototypes for semiconductor and MEMS manufacturers, and Fabless IC design firms. Quik-Pak can process any plastic package at any time.

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